



PRODUCT DATASHEET



- EMC 2-PIN SMD
- 3020 0.52t Series
- ► Green (520-535nm)



3020 0.52t Series



FEATURES:

- Package: TOP View EMC White SMT Package
- Forward Current: 150mA
- Forward Voltage (typ.): 3.0V
- Luminous Flux (typ.): 38lm@150mA
- Colour: Green
- Wavelength: 520-535nm
- Viewing angle: 120°
- Materials:
 - Die: InGaN
 - Resin: Silicon (Water Clear)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+105°C
- Grouping parameters:
 - Forward Voltage
 - Luminous Flux
 - Dominant Wavelength
- Soldering methods: Reflow
- Preconditioning: MSL3 according to J-STD020
- Packing: 8mm tape with Max.5000pcs/reel, ø180mm (7")

N0G20S59

3020 0.52t Series

APPLICATIONS:

- Decorative Lighting
- Portable Lighting
- Outdoor Lighting

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- Commercial Lighting
- Architectural Lighting



CHARACTERISTICS:

Parameter Symbol Ratings Unit DC Forward Current 200 IF mΑ **PULSE Forward Current** 300 IFP mΑ **Powewr Dissipation** \mathbf{P}_{D} 680 mW V **Reverse Voltage** VR 5 Reverse Current @5V IR 10 μΑ °C Junction Temperature Tj 110 Electrostatic Discharge (HBM: MIL-STD-883 C 2) ESD 2000 V **Thermal Resistance** 36 °C/W Rthj-sp **Operating Temperature** -40~+85 °C $\mathsf{T}_{\mathsf{OPR}}$ Storage Temperature -40~+105 °C Tstg Soldering Temperature (10S) T_{SOL} 230 or 260 for 10S °C

Absolute Maximum Characteristics (Ta=25°C)

Electrical & Optical Characteristics (Ta=25°C)

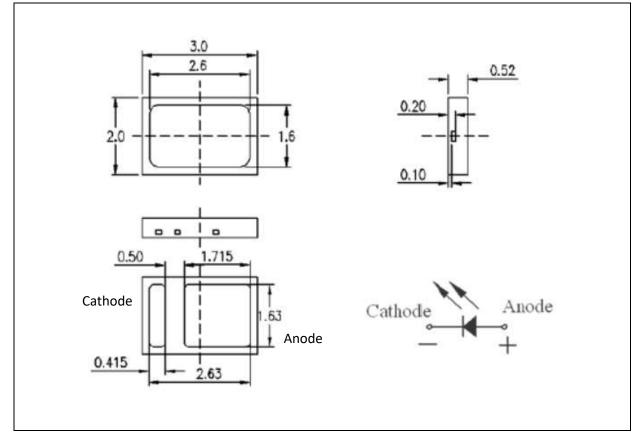
Parameter	Symbol	Values			Unit	Test
		Min.	Тур.	Max.	Onit	Condition
Forward Voltage	VF	2.6	3.0	3.4	V	I⊧=150mA
Luminous Flux	Φv	30	38	51	lm	I⊧=150mA
Dominant Wavelength	λ_{D}	520		535	nm	l⊧=150mA
Viewing Angle	2 0 1/2		120		deg	l⊧=150mA

1. Luminous flux (Φ_V) ±7%, Forward Voltage (V_F) ±0.05V, Viewing angle(2 $\theta_{1/2}$) ±10°



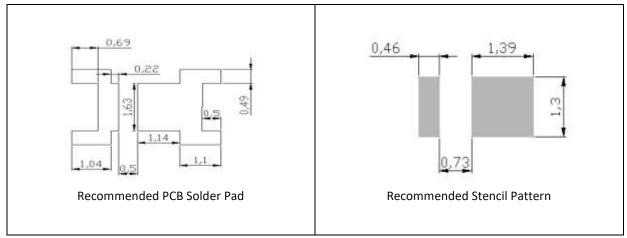
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- **2.** Tolerance ± 0.12 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Code	Min.	Max.	Unit
V2628	2.6	2.8	
V2830	2.8	3.0	V
V3032	3.0	3.2	v
V3234	3.2	3.4	

Forward Voltage Classifications (I_F = 150mA):

Luminous Flux Classifications (I_F = 150mA):

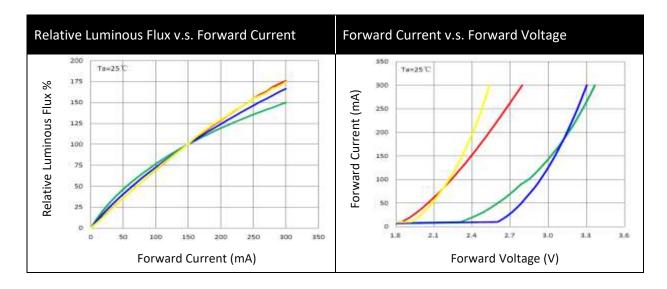
Code	Min.	Max.	Unit
AL	30	37	
AM	37	44	lm
AN	44	51	

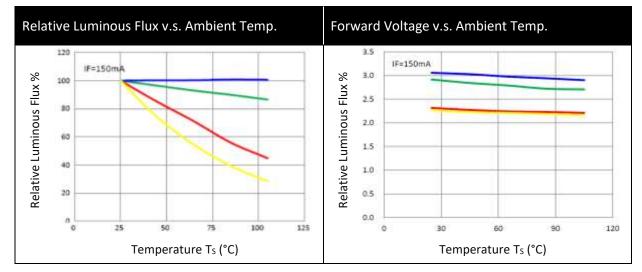
Dominant Wavelength Classifications (I_F = 150mA):

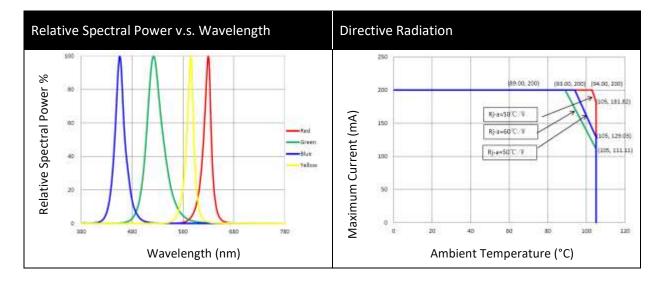
Code	Min.	Max.	Unit
G520	520	525	
G525	525	530	nm
G530	530	535	



ELECTRO-OPTICAL CHARACTERISTICS:

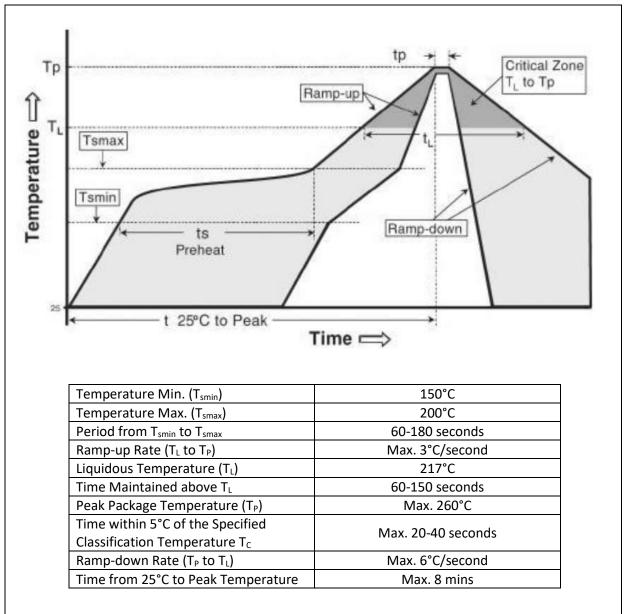








RECOMMENDED SOLDERING PROFILE:



Reflow Lead-free Solder:

Note:

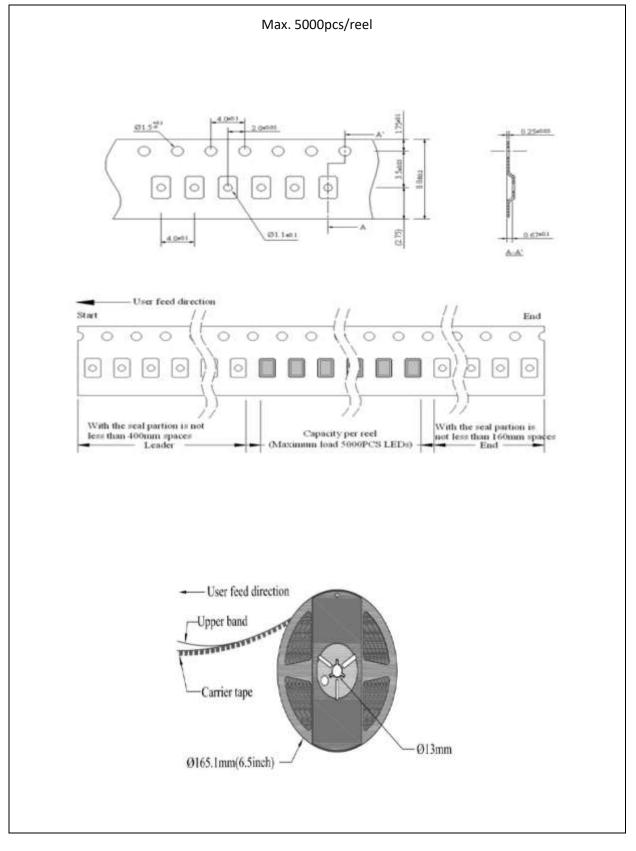
- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.

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PACKING SPECIFICATION:

Reel Dimension:



PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

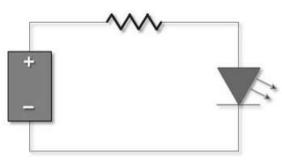
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

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REVISION RECORD:

Version	Date	Summary of Revision
A1.0	28/01/2017	Datasheet set-up.
A1.1	30/03/2018	Lead frame upgrade.
A1.2	03/04/2018	Correct wrong polarity drawing from last revision.
A1.3	05/12/2018	Revise operating temperature range.